



US3M

3.0A SURFACE MOUNT ULTRA-FAST RECTIFIER

Product Summary (@T_A = +25°C)

V _{RRM} (V)	I ₀ (A)	V _F (V)	Ι _R (μΑ)
1,000	3	1.8	10

Description

3.0A Surface Mount Glass Passivated Rectifier in SMC package offers high current capability and ultra-fast recovery time for high efficiency. Designed with glass passivated die construction for high reliability, this device is ideal for applications such as:

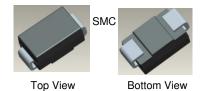
- Power Supplies
- Lighting Ballasts

Features and Benefits

- Glass Passivated Die Construction
- High Current Capability
- Ultra-Fast Recovery Time for High Efficiency
- Maximum Operating Junction Temperature of +175°C
- Lead Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SMC
- Case Material: Molded Plastic.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead-Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.21 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
US3M-13	SMC	3,000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

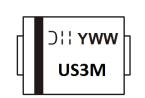
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definations of Halogen- and Antimony-free, "Green"

and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



SMC

US3M = Product Type Marking Code Clinic = Manufacturer's Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 4 for 2014) WW = Week Code 01 to 53



Unit

۷ ٧ А А

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.							
Characteristic		Value					
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	1,000					
RMS Reverse Voltage	V _{R(RMS)}	700					
Average Rectified Output Current @ T _T = +75°C	lo	3.0					
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	120					

Thermal Characteristics

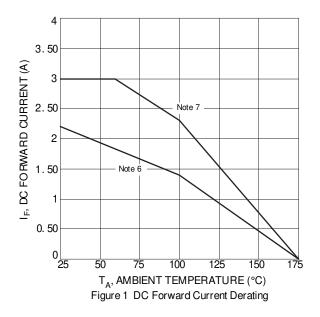
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 7)	$R_{\theta JT}$	26	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-65 to +175	°C

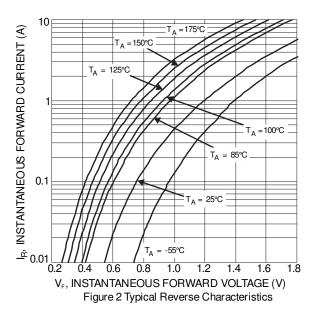
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V _{(BR)R}	1,000	—	—	V	I _R =10µA
Forward Voltage	VF	_	1.5	1.8	V	I _F = 3.0A
Leakage Current (Note 5)	I _R	_	2.2 14	10 500	μA	V _R =1,000V, T _A = +25°C V _R =1,000V, T _A = +125°C
Reverse Recovery Time	trr	_	70	85	ns	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$
Total Capacitance	Ст	_	25	_	pF	V _R = 4V, f =1.0MHz
Notes: 5. Short duration pulse test used to minimize self-heating effect.						

5. Short duration pulse test used to minimize self-heating effect.

Device mounted on FR-4 substrate, 1" x 1", 2oz, single-sided, PC boards with 0.15" x 0.26" copper pads.
 Device mounted on FR-4 substrate, 1" x 1", 2oz, single-sided, PC boards with 0.56" x 0.73" copper pads.







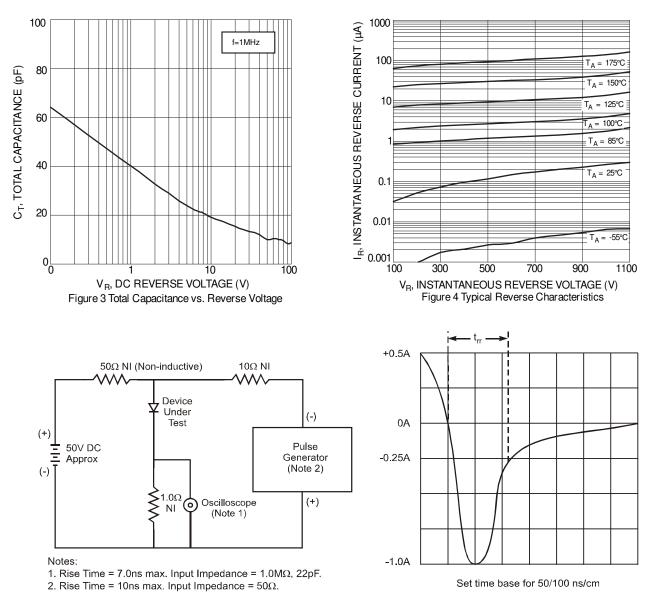


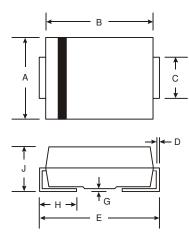
Figure 5 Reverse Recovery Time Characteristic and Test Circuit



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Package Outline Dimensions

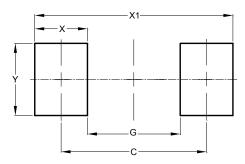
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SMC			
Dim	Min	Max	
Α	5.59	6.22	
В	6.60	7.11	
С	2.75	3.18	
D	0.15	0.31	
E	7.75	8.13	
G	0.10	0.20	
Н	0.76	1.52	
J	2.00	2.50	
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	6.90
G	4.40
Х	2.50
X1	9.40
Y	3.30



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